# **Special Issue**

# Deep Learning-Enhanced Structural Health Monitoring

# Message from the Guest Editors

This Special Issue calls for high-quality original research articles, review articles, and technical notes focused on such emergent technologies and the latest advances in the field. Topics may cover broad areas related to the development or enhancement of applied methodologies, new SHM architectures, wireless sensing networks, smart devices, optimal sensors placement, issues related to structural implementation, synthetic data generation and processing, and interdisciplinary applications. Special Issue Link: https://www.mdpi.com/journal/applsci/special\_issues/3U7HAO4J6T

### **Guest Editors**

## Dr. Federica Angeletti

School of Aerospace Engineering, Sapienza University of Rome, Via Salaria 851-881, 00138 Rome, Italy

#### Prof. Dr. Massimo Panella

Department of Information Engineering, Electronics and Telecommunications (DIET), Sapienza University of Rome, Via Eudossiana 18, 00184 Rome, Italy

### Deadline for manuscript submissions

closed (31 October 2024)



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As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

### Editor-in-Chief

Prof. Dr. Giulio Nicola Cerullo

Dipartimento di Fisica, Politecnico di Milano, Piazza L. da Vinci 32, 20133 Milano, Italy

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